PCN Number: 20200610001 PCN Date: July 27, 2020									
Title: Datasheet for UCC21750-Q1									
Customer Contact: P	CN Manager				D	ept:	Quality Services		
Change Type:									
Assembly Site			Design			Wa	fer Bump Site		
Assembly Process			Data Sheet			Wa	fer Bump Material		
Assembly Materials			Part number change			Wafer Bump Process			
Mechanical Specification		=	Test Site			Wafer Fab Site			
Packing/Shipping/Labeling			Test Process			= -	Wafer Fab Materials		
		Nad	Lifi Li -	n Dotaile		Wa	fer Fab Process		
Notification Details									
Description of Change: Toyog Instruments Inserporated is appearating an information only natification									
Texas Instruments Incorporated is announcing an information only notification.									
The product datasheet(s) is being updated as summarized below. The following change history provides further details.									
_	tory provide	C3 10	artifici deta	113.					
TEXAS							UCC21750-Q1		
INSTRUMENTS SLUSDH9B – SEPTEMBER 2019 – REVISED MARCH 2020									
Changes from Revision A (March 2020) to Revision B Page									
Deleted test voltage, 9600\	/, from value co	olumn	١				7		
•									
The datasheet number will be changing.									
Device Family				Change From:			Change To:		
UCC21750-Q1			SLUS	SLUSDH9A			SLUSDH9B		
These changes may be reviewed at the datasheet links provided.									
http://www.ti.com/produc/UCC21750-Q1									
Reason for Change:									
To accurately reflect device characteristics.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
No anticipated impact. This is a specification change announcement only. There are no changes									
to the actual device.									
Changes to product identification resulting from this PCN:									
None.									
Product Affected:									
	110024752	0001	MDO1						
UCC21750QDWQ1	UCC21750QDWRQ1								

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
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